





#### **100V PNP MEDIUM POWER TRANSISTOR** PowerDI<sup>®</sup>5

#### **Features**

- 43% smaller than SOT223; 60% smaller than TO252
- Maximum height just 1.1mm
- Rated up to 3.2W
- $V_{CEO} = -100V$
- $I_C = -5A$ ;  $I_{CM} = -10A$
- Low Saturation voltage
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)

### **Applications**

SLIC DC-DC Converter

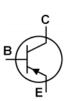
#### **Mechanical Data**

- Case: PowerDI®5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.093 grams (approximate)

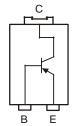


Top View

Bottom View



Device Schematic



Pin-out diagram

### Ordering Information (Note 3)

Part Number	Case	Packaging
DXT2013P5-13	PowerDI <sup>®</sup> 5	5000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com
- 3. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

### **Marking Information**



DXT2013 = Product Type Marking Code Oll = Manufacturers' Code Marking K = Factory Designator YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 09 for 2009) WW = Week code (01 to 53)





## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-140	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-100	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	Ic	-5	A
Peak Pulse Current	I <sub>CM</sub>	-10	А

## **Thermal Characteristics**

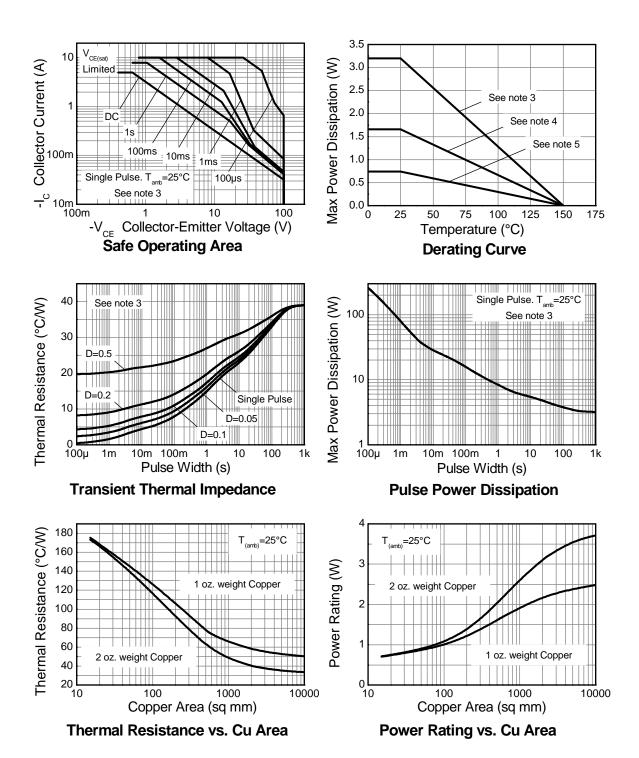
Characteristic	Symbol	Value	Unit
Power Dissipation @ T <sub>A</sub> = 25°C (Note 4)	$P_{D}$	3.2	W
Thermal Resistance, Junction to Ambient Air (Note 4) @T <sub>A</sub> = 25°C	$R_{ heta JA}$	39	°C/W
Power Dissipation @ T <sub>A</sub> = 25°C (Note 5)	P <sub>D</sub>	1.7	W
Thermal Resistance, Junction to Ambient Air (Note 5) @T <sub>A</sub> = 25°C	$R_{ heta JA}$	75	°C/W
Power Dissipation @ T <sub>A</sub> = 25°C (Note 6)	$P_{D}$	0.74	W
Thermal Resistance, Junction to Ambient Air (Note 6) @T <sub>A</sub> = 25°C	$R_{ heta JA}$	169	°C/W
Thermal Resistance, Junction to Collector Terminal	$R_{ heta JT}$	5.6	°C/W
Operating and Storage Temperature Range	$T_J$ , $T_{STG}$	-55 to +150	°C

Notes:

- 4. Device mounted on FR-4 PCB, single sided 2 oz. copper, collector pad dimensions 50mm x 50mm.
  5. Device mounted on FR-4 PCB, single sided 1 oz. copper, collector pad dimensions 25mm x 25mm.
  6. Device mounted on FR-4 PCB, single sided 1 oz. copper, minimum recommended pad layout.

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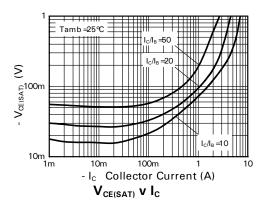
## **Electrical Characteristics** @TA = 25°C unless otherwise specified

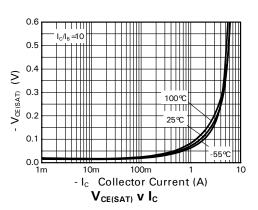
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-140	-160	_	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 7)	V <sub>(BR)CEO</sub>	-100	-115	_	V	$I_C = -10 \text{mA}$
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-7.0	-8.1	_	V	$I_E = -100 \mu A$
ollector Cutoff Current	1	_	<1	-20	nA	V <sub>CB</sub> = -100V
	Ісво		—	-0.5	μΑ	V <sub>CB</sub> = -100V, T <sub>amb</sub> = 100 °C
Collector Cutoff Current	I <sub>CER</sub>		<1	-20	nA	V <sub>CB</sub> = -100V
nector Cuton Current	R≤1kΩ		_	-0.5	μΑ	V <sub>CB</sub> = -100V, T <sub>amb</sub> = 100 °C
Emitter Cutoff Current	I <sub>EBO</sub>		<1	-10	nA	$V_{EB} = -6V$
			-20	-30		$I_C = -0.1A$ , $I_B = -10mA$
Collector-Emitter Saturation Voltage (Note 7)	V05( )		-70	-90	mV	$I_C = -1A$ , $I_B = -100mA$
Concetor-Emitter Cataration Voltage (Note 1)	V <sub>CE(sat)</sub>	_	-120	-150	IIIV	$I_C = -2A$ , $I_B = -200mA$
			-240	-340		$I_C = -4A$ , $I_B = -400mA$
Base-Emitter Saturation Voltage (Note 7)	V <sub>BE(sat)</sub>	_	-985	-1100	mV	$I_C = -4A$ , $I_B = -400mA$
Base-Emitter Turn-On Voltage (Note 7)	V <sub>BE(on)</sub>	_	-920	-1050	mV	$V_{CE} = -4V, I_{C} = -2A$
		100	250	_		$I_C = -10 \text{mA}, V_{CE} = -1 \text{V}$
C Current Gain (Note 7)		100	200	300		$I_C = -1A$ , $V_{CE} = -1V$
	h <sub>FE</sub>	25	50	_	_	$I_C = -3A$ , $V_{CE} = -1V$
		15 —	30	_		$I_C = -4A$ , $V_{CE} = -1V$
			5	_		I <sub>C</sub> = -10A, V <sub>CE</sub> = -1V
Transition Frequency	f <sub>T</sub>	_	125		MHz	$I_C = -100 \text{mA}, V_{CE} = -10 \text{V},$
Output Capacitance	C <sub>obo</sub>		42		pF	f = 50MHz V <sub>CB</sub> = -10V, f = 1MHz
Output Oapacitanice			42		ns	Ic = -1A, Vcc = -10V,
itching Times	t <sub>on</sub> t <sub>off</sub>		540		ns	$I_{B1} = I_{B2} = -100 \text{mA}$
	Lott		J-10		110	181 - 182 = - 100111A

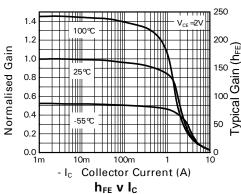
Notes: 7. Pulse Test: Pulse width  $\leq 300 \mu s$ . Duty cycle  $\leq 2.0\%$ .

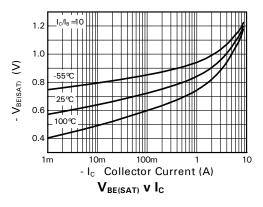


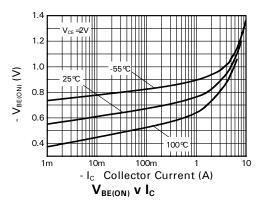
## **Typical Characteristic**





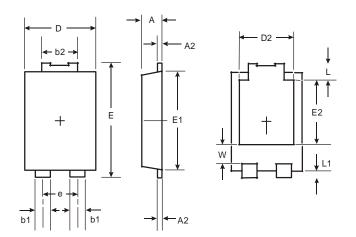






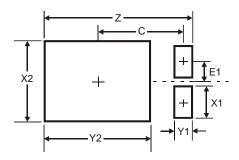


# **Package Outline Dimensions**



	PowerDI <sup>®</sup> 5					
Dim	Min	Max				
Α	1.05	1.15				
A2	0.33	0.43				
b1	0.80	0.99				
b2	1.70	1.88				
D	3.90	4.05				
D2	3.054	Тур				
E		6.60				
е	1.84 Typ					
E1	5.30	5.45				
E2	3.549 Typ					
L	0.75	0.95				
L1	0.50	0.65				
W	1.10	1.41				
All Di	All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	6.6
X1	1.4
X2	3.6
Y1	0.8
Y2	4.7
С	3.87
F1	0.9





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